



Welcome to [E-XFL.COM](https://www.e-xfl.com)

### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

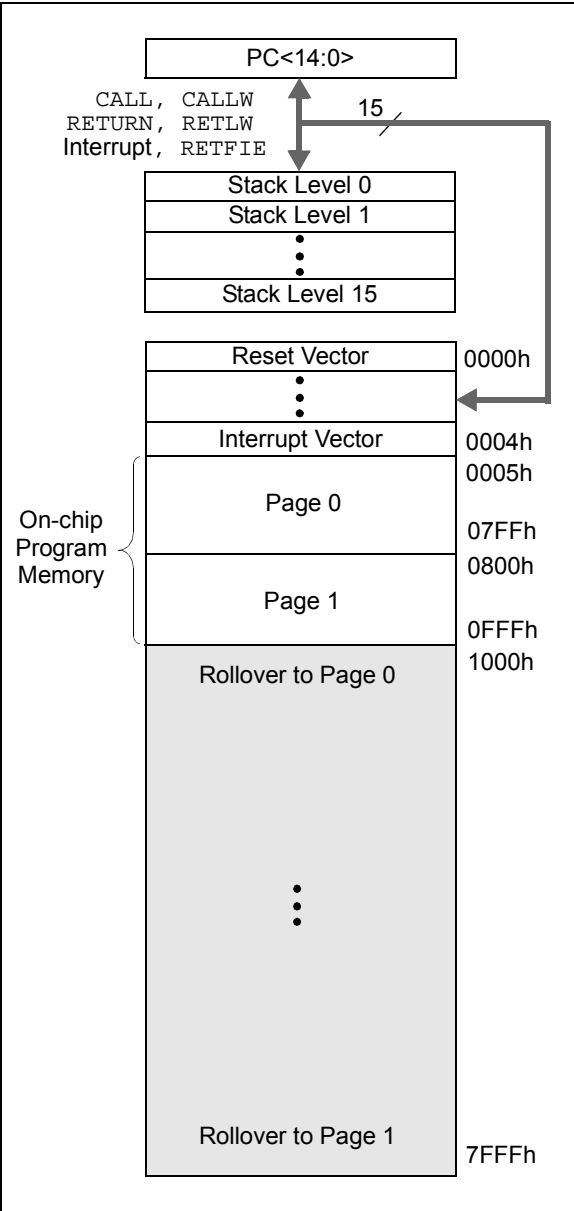
### Applications of "[Embedded - Microcontrollers](#)"

#### Details

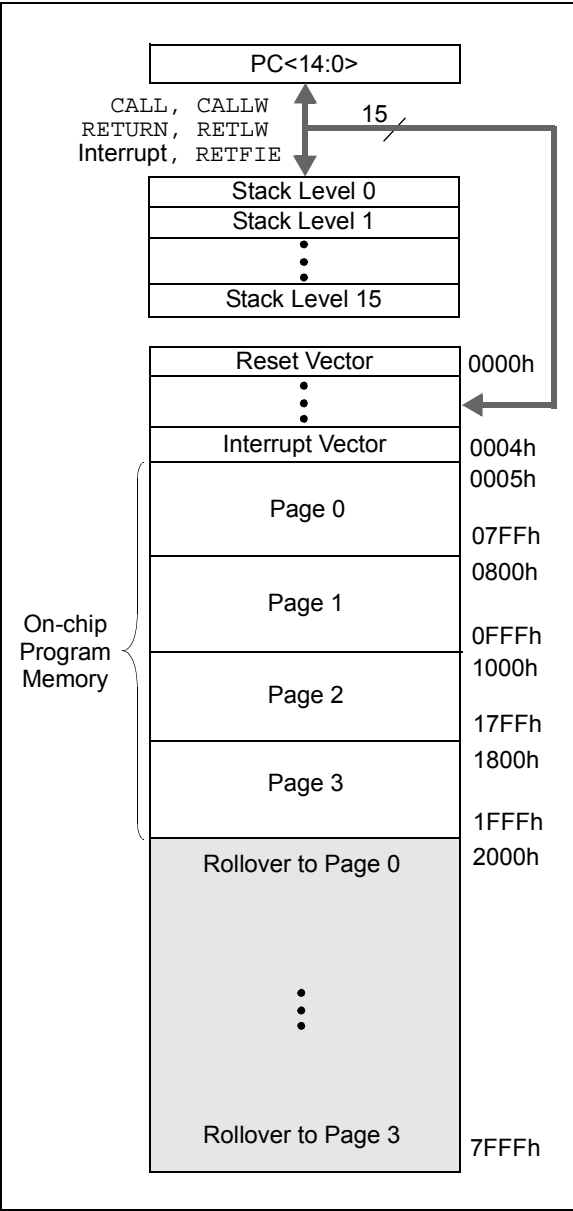
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I <sup>2</sup> C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LCD, POR, PWM, WDT
Number of I/O	36
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 14x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic16f1937-i-pt">https://www.e-xfl.com/product-detail/microchip-technology/pic16f1937-i-pt</a>

# PIC16(L)F1934/6/7

**FIGURE 3-1: PROGRAM MEMORY MAP AND STACK FOR 4KW PARTS**



**FIGURE 3-2: PROGRAM MEMORY MAP AND STACK FOR 8KW PARTS**



## 5.4 Two-Speed Clock Start-up Mode

Two-Speed Start-up mode provides additional power savings by minimizing the latency between external oscillator start-up and code execution. In applications that make heavy use of the Sleep mode, Two-Speed Start-up will remove the external oscillator start-up time from the time spent awake and can reduce the overall power consumption of the device. This mode allows the application to wake-up from Sleep, perform a few instructions using the INTOSC internal oscillator block as the clock source and go back to Sleep without waiting for the external oscillator to become stable.

Two-Speed Start-up provides benefits when the oscillator module is configured for LP, XT or HS modes. The Oscillator Start-up Timer (OST) is enabled for these modes and must count 1024 oscillations before the oscillator can be used as the system clock source.

If the oscillator module is configured for any mode other than LP, XT or HS mode, then Two-Speed Start-up is disabled. This is because the external clock oscillator does not require any stabilization time after POR or an exit from Sleep.

If the OST count reaches 1024 before the device enters Sleep mode, the OSTS bit of the OSCSTAT register is set and program execution switches to the external oscillator. However, the system may never operate from the external oscillator if the time spent awake is very short.

**Note:** Executing a `SLEEP` instruction will abort the oscillator start-up time and will cause the OSTS bit of the OSCSTAT register to remain clear.

### 5.4.1 TWO-SPEED START-UP MODE CONFIGURATION

Two-Speed Start-up mode is configured by the following settings:

- IESO (of the Configuration Word 1) = 1; Internal/External Switchover bit (Two-Speed Start-up mode enabled).
- SCS (of the OSCCON register) = 00.
- FOSC<2:0> bits in the Configuration Word 1 configured for LP, XT or HS mode.

Two-Speed Start-up mode is entered after:

- Power-on Reset (POR) and, if enabled, after Power-up Timer (PWRT) has expired, or
- Wake-up from Sleep.

**TABLE 5-1: OSCILLATOR SWITCHING DELAYS**

Switch From	Switch To	Frequency	Oscillator Delay
Sleep/POR	LFINTOSC <sup>(1)</sup> MFINTOSC <sup>(1)</sup> HFINTOSC <sup>(1)</sup>	31 kHz 31.25 kHz-500 kHz 31.25 kHz-16 MHz	Oscillator Warm-up Delay (TWARM)
Sleep/POR	EC, RC <sup>(1)</sup>	DC – 32 MHz	2 cycles
LFINTOSC	EC, RC <sup>(1)</sup>	DC – 32 MHz	1 cycle of each
Sleep/POR	Timer1 Oscillator LP, XT, HS <sup>(1)</sup>	32 kHz-20 MHz	1024 Clock Cycles (OST)
Any clock source	MFINTOSC <sup>(1)</sup> HFINTOSC <sup>(1)</sup>	31.25 kHz-500 kHz 31.25 kHz-16 MHz	2 $\mu$ s (approx.)
Any clock source	LFINTOSC <sup>(1)</sup>	31 kHz	1 cycle of each
Any clock source	Timer1 Oscillator	32 kHz	1024 Clock Cycles (OST)
PLL inactive	PLL active	16-32 MHz	2 ms (approx.)

**Note 1:** PLL inactive.

# PIC16(L)F1934/6/7

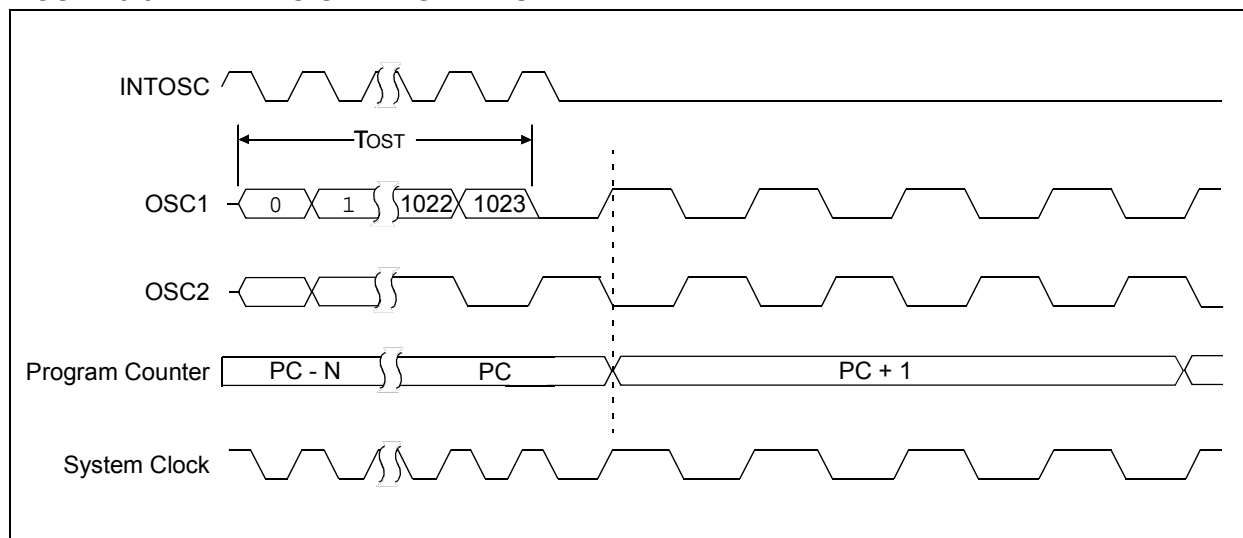
## 5.4.2 TWO-SPEED START-UP SEQUENCE

1. Wake-up from Power-on Reset or Sleep.
2. Instructions begin execution by the internal oscillator at the frequency set in the IRCF<3:0> bits of the OSCCON register.
3. OST enabled to count 1024 clock cycles.
4. OST timed out, wait for falling edge of the internal oscillator.
5. OSTS is set.
6. System clock held low until the next falling edge of new clock (LP, XT or HS mode).
7. System clock is switched to external clock source.

## 5.4.3 CHECKING TWO-SPEED CLOCK STATUS

Checking the state of the OSTS bit of the OSCSTAT register will confirm if the microcontroller is running from the external clock source, as defined by the FOSC<2:0> bits in the Configuration Word 1, or the internal oscillator.

**FIGURE 5-8: TWO-SPEED START-UP**



# PIC16(L)F1934/6/7

## 9.1.1 WAKE-UP USING INTERRUPTS

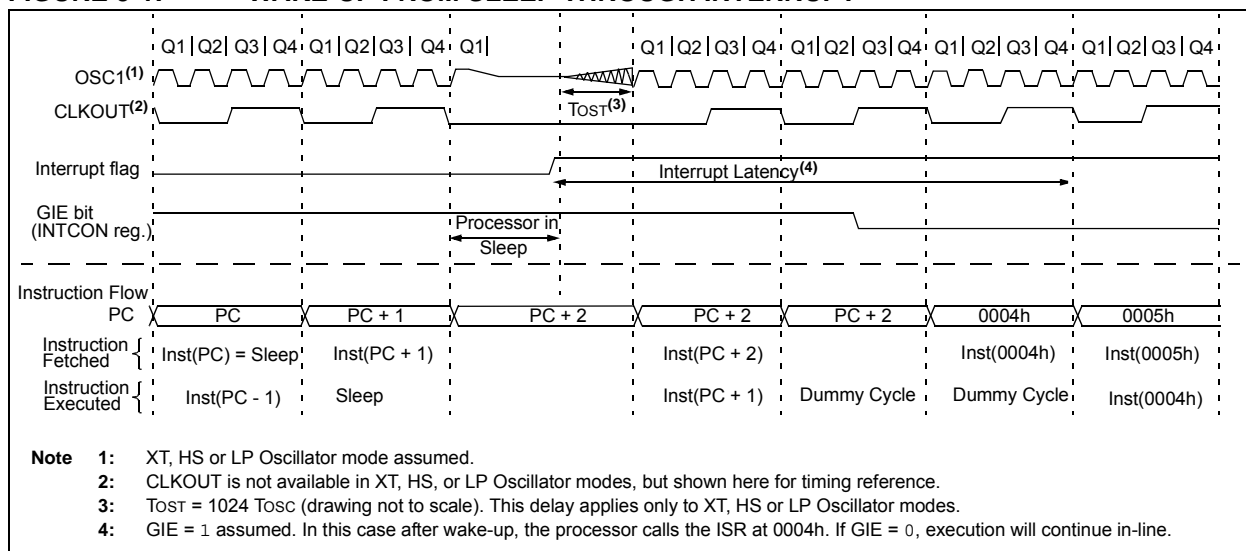
When global interrupts are disabled (GIE cleared) and any interrupt source has both its interrupt enable bit and interrupt flag bit set, one of the following will occur:

- If the interrupt occurs **before** the execution of a **SLEEP** instruction
  - **SLEEP** instruction will execute as a NOP.
  - WDT and WDT prescaler will not be cleared
  - $\overline{TO}$  bit of the STATUS register will not be set
  - $\overline{PD}$  bit of the STATUS register will not be cleared.

- If the interrupt occurs **during or after** the execution of a **SLEEP** instruction
  - **SLEEP** instruction will be completely executed
  - Device will immediately wake-up from Sleep
  - WDT and WDT prescaler will be cleared
  - $\overline{TO}$  bit of the STATUS register will be set
  - $\overline{PD}$  bit of the STATUS register will be cleared.

Even if the flag bits were checked before executing a **SLEEP** instruction, it may be possible for flag bits to become set before the **SLEEP** instruction completes. To determine whether a **SLEEP** instruction executed, test the  $\overline{PD}$  bit. If the  $\overline{PD}$  bit is set, the **SLEEP** instruction was executed as a NOP.

**FIGURE 9-1: WAKE-UP FROM SLEEP THROUGH INTERRUPT**



**TABLE 9-1: SUMMARY OF REGISTERS ASSOCIATED WITH POWER-DOWN MODE**

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
INTCON	GIE	PEIE	TMR0IE	INTE	IOCFIE	TMR0IF	INTF	IOCFIF	98
IOCBF	IOCBF7	IOCBF6	IOCBF5	IOCBF4	IOCBF3	IOCBF2	IOCBF1	IOCBF0	152
IOCBN	IOCBN7	IOCBN6	IOCBN5	IOCBN4	IOCBN3	IOCBN2	IOCBN1	IOCBN0	152
IOCBP	IOCBP7	IOCBP6	IOCBP5	IOCBP4	IOCBP3	IOCBP2	IOCBP1	IOCBP0	152
PIE1	TMR1GIE	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	99
PIE2	OSFIE	C2IE	C1IE	EEIE	BCLIE	LCDIE	—	CCP2IE	100
PIE3	—	CCP5IE	CCP4IE	CCP3IE	TMR6IE	—	TMR4IE	—	101
PIR1	TMR1GIF	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	102
PIR2	OSFIF	C2IF	C1IF	EEIF	BCLIF	LCDIF	—	CCP2IF	103
PIR3	—	CCP5IF	CCP4IF	CCP3IF	TMR6IF	—	TMR4IF	—	104
STATUS	—	—	—	$\overline{TO}$	$\overline{PD}$	Z	DC	C	29
WDTCON	—	—	WDTPS<4:0>					SWDTEN	113

**Legend:** — = unimplemented location, read as '0'. Shaded cells are not used in Power-down mode.

## REGISTER 12-2: PORTA: PORTA REGISTER

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
RA7	RA6	RA5	RA4	RA3	RA2	RA1	RA0
bit 7							bit 0

### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7-0 **RA<7:0>**: PORTA I/O Value bits<sup>(1)</sup>  
 1 = Port pin is > VIH  
 0 = Port pin is < VIL

**Note 1:** Writes to PORTA are actually written to corresponding LATA register. Reads from PORTA register is return of actual I/O pin values.

## REGISTER 12-3: TRISA: PORTA TRI-STATE REGISTER

R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1
TRISA7	TRISA6	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0
bit 7							bit 0

### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7-0 **TRISA<7:0>**: PORTA Tri-State Control bit  
 1 = PORTA pin configured as an input (tri-stated)  
 0 = PORTA pin configured as an output

## REGISTER 12-4: LATA: PORTA DATA LATCH REGISTER

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
LATA7	LATA6	LATA5	LATA4	LATA3	LATA2	LATA1	LATA0
bit 7							bit 0

### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

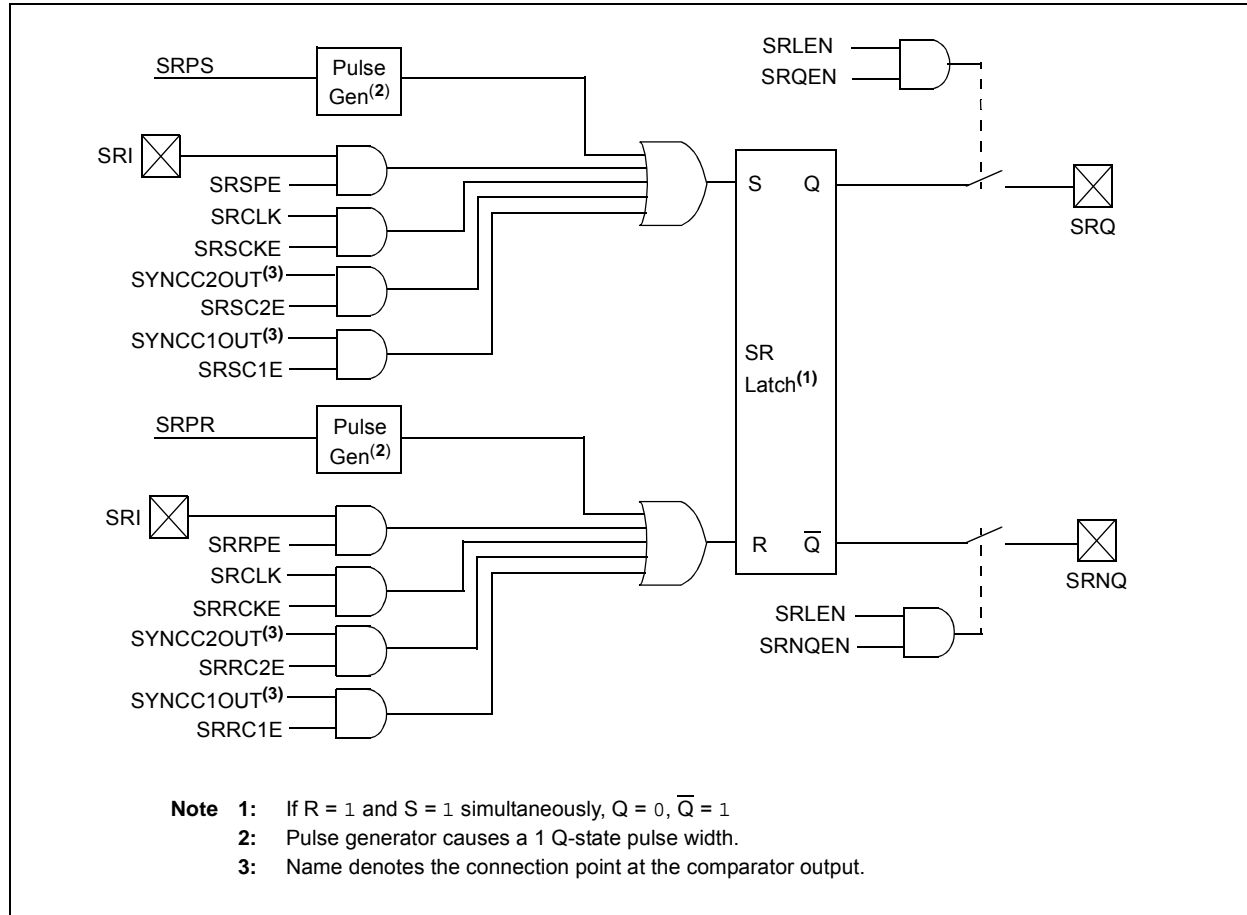
'0' = Bit is cleared

bit 7-0 **LATA<7:0>**: PORTA Output Latch Value bits<sup>(1)</sup>

**Note 1:** Writes to PORTA are actually written to corresponding LATA register. Reads from PORTA register is return of actual I/O pin values.

# PIC16(L)F1934/6/7

**FIGURE 19-1: SR LATCH SIMPLIFIED BLOCK DIAGRAM**



# PIC16(L)F1934/6/7

## 23.4.2 FULL-BRIDGE MODE

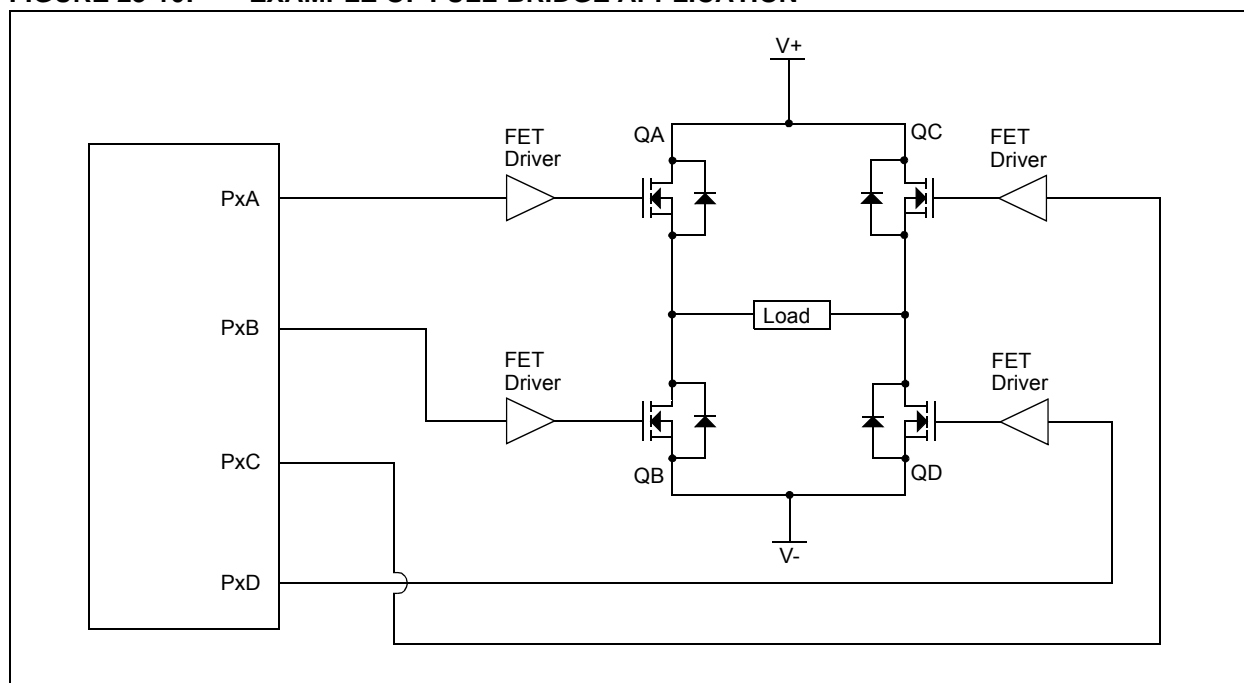
In Full-Bridge mode, all four pins are used as outputs. An example of Full-Bridge application is shown in Figure 23-10.

In the Forward mode, pin CCPx/PxA is driven to its active state, pin PxD is modulated, while PxB and PxC will be driven to their inactive state as shown in Figure 23-11.

In the Reverse mode, PxC is driven to its active state, pin PxB is modulated, while PxA and PxD will be driven to their inactive state as shown Figure 23-11.

PxA, PxB, PxC and PxD outputs are multiplexed with the PORT data latches. The associated TRIS bits must be cleared to configure the PxA, PxB, PxC and PxD pins as outputs.

**FIGURE 23-10: EXAMPLE OF FULL-BRIDGE APPLICATION**





# PIC16(L)F1934/6/7

## 24.5.6 CLOCK STRETCHING

Clock stretching occurs when a device on the bus holds the SCL line low, effectively pausing communication. The slave may stretch the clock to allow more time to handle data or prepare a response for the master device. A master device is not concerned with stretching as anytime it is active on the bus and not transferring data it is stretching. Any stretching done by a slave is invisible to the master software and handled by the hardware that generates SCL.

The CKP bit of the SSPCON1 register is used to control stretching in software. Any time the CKP bit is cleared, the module will wait for the SCL line to go low and then hold it. Setting CKP will release SCL and allow more communication.

### 24.5.6.1 Normal Clock Stretching

Following an  $\overline{\text{ACK}}$  if the  $\text{R}\overline{\text{W}}$  bit of SSPSTAT is set, a read request, the slave hardware will clear CKP. This allows the slave time to update SSPBUF with data to transfer to the master. If the SEN bit of SSPCON2 is set, the slave hardware will always stretch the clock after the ACK sequence. Once the slave is ready, CKP is set by software and communication resumes.

**Note 1:** The BF bit has no effect on whether the clock will be stretched or not. This is different than previous versions of the module that would not stretch the clock, clear CKP, if SSPBUF was read before the 9th falling edge of SCL.

**2:** Previous versions of the module did not stretch the clock for a transmission if SSPBUF was loaded before the 9th falling edge of SCL. It is now always cleared for read requests.

### 24.5.6.2 10-bit Addressing Mode

In 10-bit Addressing mode, when the UA bit is set, the clock is always stretched. This is the only time the SCL is stretched without CKP being cleared. SCL is released immediately after a write to SSPADD.

**Note:** Previous versions of the module did not stretch the clock if the second address byte did not match.

### 24.5.6.3 Byte NACKing

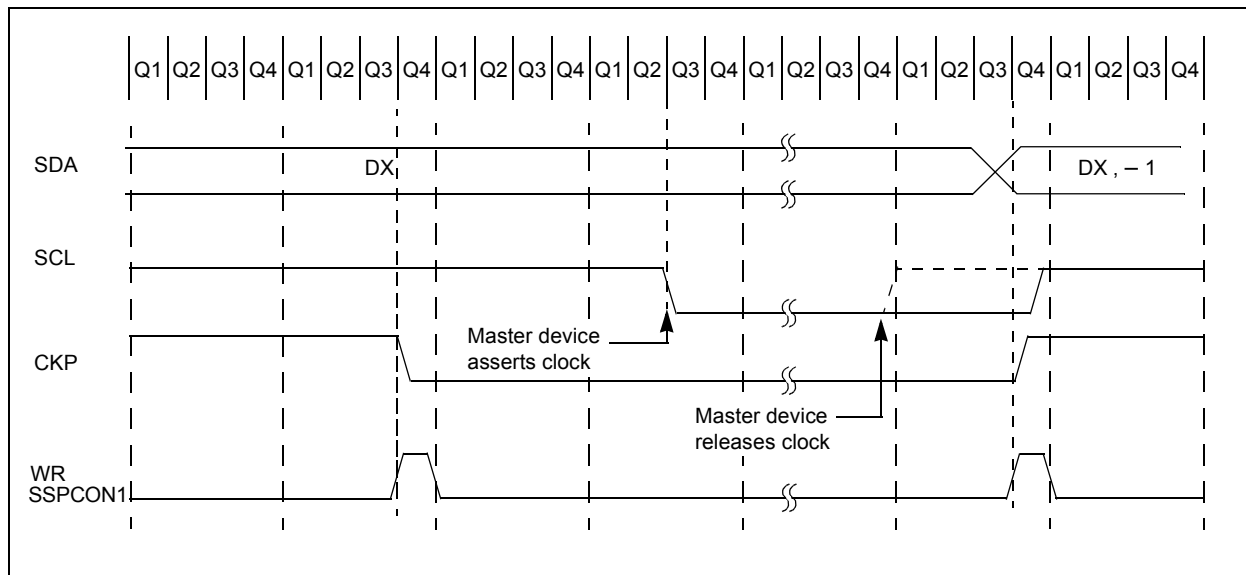
When the AHEN bit of SSPCON3 is set; CKP is cleared by hardware after the 8th falling edge of SCL for a received matching address byte. When the DHEN bit of SSPCON3 is set; CKP is cleared after the 8th falling edge of SCL for received data.

Stretching after the 8th falling edge of SCL allows the slave to look at the received address or data and decide if it wants to ACK the received data.

## 24.5.7 CLOCK SYNCHRONIZATION AND THE CKP BIT

Any time the CKP bit is cleared, the module will wait for the SCL line to go low and then hold it. However, clearing the CKP bit will not assert the SCL output low until the SCL output is already sampled low. Therefore, the CKP bit will not assert the SCL line until an external I<sup>2</sup>C master device has already asserted the SCL line. The SCL output will remain low until the CKP bit is set and all other devices on the I<sup>2</sup>C bus have released SCL. This ensures that a write to the CKP bit will not violate the minimum high time requirement for SCL (see Figure 24-22).

**FIGURE 24-23: CLOCK SYNCHRONIZATION TIMING**



# PIC16(L)F1934/6/7

**TABLE 24-3: SUMMARY OF REGISTERS ASSOCIATED WITH I<sup>2</sup>C™ OPERATION**

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE	PEIE	TMR0IE	INTE	IOCFE	TMR0IF	INTF	IOCF	98
PIE1	TMR1GIE	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	99
PIE2	OSFIE	C2IE	C1IE	EEIE	BCLIE	—	—	CCP2IE <sup>(1)</sup>	100
PIR1	TMR1GIF	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	102
PIR2	OSFIF	C2IF	C1IF	EEIF	BCLIF	—	—	CCP2IF <sup>(1)</sup>	103
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	142
SSPADD	ADD<7:0>								290
SSPBUF	MSSP Receive Buffer/Transmit Register								243*
SSPCON1	WCOL	SSPOV	SSPEN	CKP	SSPM<3:0>				287
SSPCON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	288
SSPCON3	ACKTIM	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN	289
SSPMSK	MSK<7:0>								290
SSPSTAT	SMP	CKE	D/ $\bar{A}$	P	S	R/ $\bar{W}$	UA	BF	286

**Legend:** — = unimplemented location, read as '0'. Shaded cells are not used by the MSSP module in I<sup>2</sup>C™ mode.

\* Page provides register information.

**Note 1:** PIC16F1934 only.

## 25.0 ENHANCED UNIVERSAL SYNCHRONOUS ASYNCHRONOUS RECEIVER TRANSMITTER (EUSART)

The Enhanced Universal Synchronous Asynchronous Receiver Transmitter (EUSART) module is a serial I/O communications peripheral. It contains all the clock generators, shift registers and data buffers necessary to perform an input or output serial data transfer independent of device program execution. The EUSART, also known as a Serial Communications Interface (SCI), can be configured as a full-duplex asynchronous system or half-duplex synchronous system. Full-Duplex mode is useful for communications with peripheral systems, such as CRT terminals and personal computers. Half-Duplex Synchronous mode is intended for communications with peripheral devices, such as A/D or D/A integrated circuits, serial EEPROMs or other microcontrollers. These devices typically do not have internal clocks for baud rate generation and require the external clock signal provided by a master synchronous device.

The EUSART module includes the following capabilities:

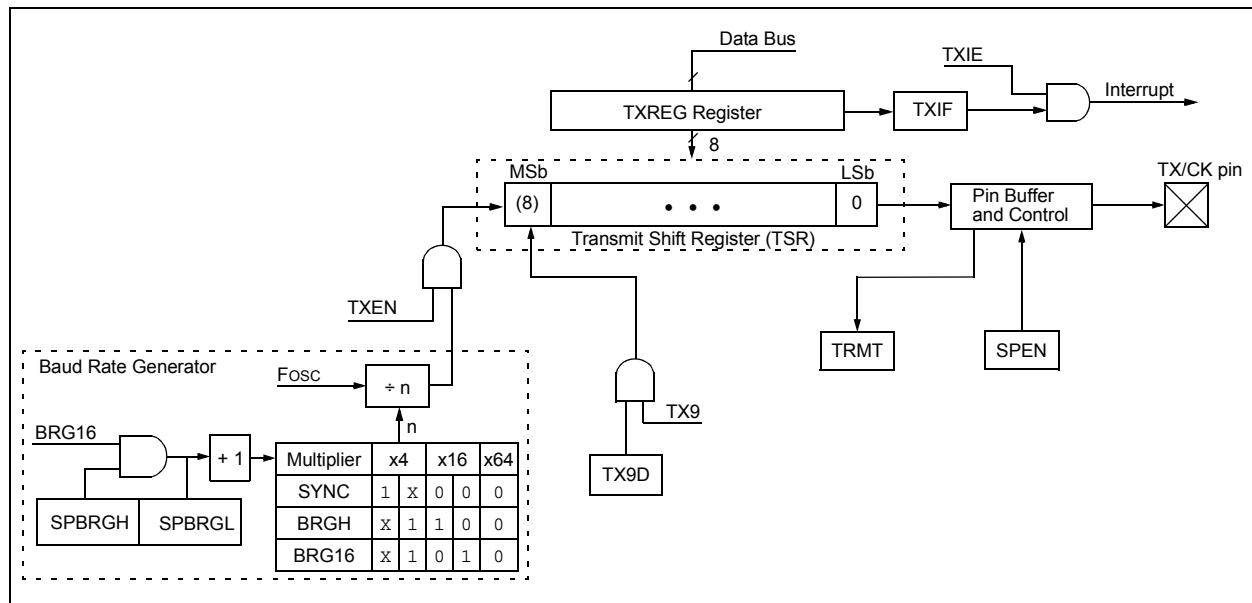
- Full-duplex asynchronous transmit and receive
- Two-character input buffer
- One-character output buffer
- Programmable 8-bit or 9-bit character length
- Address detection in 9-bit mode
- Input buffer overrun error detection
- Received character framing error detection
- Half-duplex synchronous master
- Half-duplex synchronous slave
- Programmable clock polarity in synchronous modes
- Sleep operation

The EUSART module implements the following additional features, making it ideally suited for use in Local Interconnect Network (LIN) bus systems:

- Automatic detection and calibration of the baud rate
- Wake-up on Break reception
- 13-bit Break character transmit

Block diagrams of the EUSART transmitter and receiver are shown in Figure 25-1 and Figure 25-2.

**FIGURE 25-1: EUSART TRANSMIT BLOCK DIAGRAM**



# PIC16(L)F1934/6/7

**TABLE 25-3: BAUD RATE FORMULAS**

Configuration Bits			BRG/EUSART Mode	Baud Rate Formula
SYNC	BRG16	BRGH		
0	0	0	8-bit/Asynchronous	$F_{osc}/[64 (n+1)]$
0	0	1	8-bit/Asynchronous	$F_{osc}/[16 (n+1)]$
0	1	0	16-bit/Asynchronous	
0	1	1	16-bit/Asynchronous	$F_{osc}/[4 (n+1)]$
1	0	x	8-bit/Synchronous	
1	1	x	16-bit/Synchronous	

**Legend:** x = Don't care, n = value of SPBRGH, SPBRGL register pair

**TABLE 25-4: SUMMARY OF REGISTERS ASSOCIATED WITH THE BAUD RATE GENERATOR**

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
BAUDCON	ABDOVF	RCIDL	—	SCKP	BRG16	—	WUE	ABDEN	302
RCSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	301
SPBRGL	BRG<7:0>								303*
SPBRGH	BRG<15:8>								303*
TXSTA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	300

**Legend:** — = unimplemented read as '0'. Shaded cells are not used for the Baud Rate Generator.

\* Page provides register information.

# PIC16(L)F1934/6/7

## REGISTER 27-7: LCDRL: LCD REFERENCE LADDER CONTROL REGISTERS

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	U-0	R/W-0/0	R/W-0/0	R/W-0/0
LRLAP<1:0>		LRLBP<1:0>		—	LRLAT<2:0>		
bit 7							bit 0

### Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-6 **LRLAP<1:0>**: LCD Reference Ladder A Time Power Control bits

During Time interval A (Refer to Figure 27-4):

- 00 = Internal LCD Reference Ladder is powered down and unconnected
- 01 = Internal LCD Reference Ladder is powered in Low-Power mode
- 10 = Internal LCD Reference Ladder is powered in Medium-Power mode
- 11 = Internal LCD Reference Ladder is powered in High-Power mode

bit 5-4 **LRLBP<1:0>**: LCD Reference Ladder B Time Power Control bits

During Time interval B (Refer to Figure 27-4):

- 00 = Internal LCD Reference Ladder is powered down and unconnected
- 01 = Internal LCD Reference Ladder is powered in Low-Power mode
- 10 = Internal LCD Reference Ladder is powered in Medium-Power mode
- 11 = Internal LCD Reference Ladder is powered in High-Power mode

bit 3 **Unimplemented**: Read as '0'

bit 2-0 **LRLAT<2:0>**: LCD Reference Ladder A Time Interval Control bits

Sets the number of 32 kHz clocks that the A Time Interval Power mode is active

For type A waveforms (WFT = 0):

- 000 = Internal LCD Reference Ladder is always in 'B' Power mode
- 001 = Internal LCD Reference Ladder is in 'A' Power mode for 1 clock and 'B' Power mode for 15 clocks
- 010 = Internal LCD Reference Ladder is in 'A' Power mode for 2 clocks and 'B' Power mode for 14 clocks
- 011 = Internal LCD Reference Ladder is in 'A' Power mode for 3 clocks and 'B' Power mode for 13 clocks
- 100 = Internal LCD Reference Ladder is in 'A' Power mode for 4 clocks and 'B' Power mode for 12 clocks
- 101 = Internal LCD Reference Ladder is in 'A' Power mode for 5 clocks and 'B' Power mode for 11 clocks
- 110 = Internal LCD Reference Ladder is in 'A' Power mode for 6 clocks and 'B' Power mode for 10 clocks
- 111 = Internal LCD Reference Ladder is in 'A' Power mode for 7 clocks and 'B' Power mode for 9 clocks

For type B waveforms (WFT = 1):

- 000 = Internal LCD Reference Ladder is always in 'B' Power mode.
- 001 = Internal LCD Reference Ladder is in 'A' Power mode for 1 clock and 'B' Power mode for 31 clocks
- 010 = Internal LCD Reference Ladder is in 'A' Power mode for 2 clocks and 'B' Power mode for 30 clocks
- 011 = Internal LCD Reference Ladder is in 'A' Power mode for 3 clocks and 'B' Power mode for 29 clocks
- 100 = Internal LCD Reference Ladder is in 'A' Power mode for 4 clocks and 'B' Power mode for 28 clocks
- 101 = Internal LCD Reference Ladder is in 'A' Power mode for 5 clocks and 'B' Power mode for 27 clocks
- 110 = Internal LCD Reference Ladder is in 'A' Power mode for 6 clocks and 'B' Power mode for 26 clocks
- 111 = Internal LCD Reference Ladder is in 'A' Power mode for 7 clocks and 'B' Power mode for 25 clocks

## LSLF Logical Left Shift

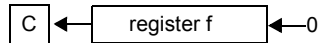
**Syntax:** `[label] LSLF f{,d}`

**Operands:**  $0 \leq f \leq 127$   
 $d \in [0,1]$

**Operation:**  $(f<7>) \rightarrow C$   
 $(f<6:0>) \rightarrow \text{dest}<7:1>$   
 $0 \rightarrow \text{dest}<0>$

**Status Affected:** C, Z

**Description:** The contents of register 'f' are shifted one bit to the left through the Carry flag. A '0' is shifted into the LSb. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f'.



## LSRF Logical Right Shift

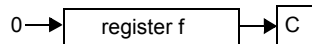
**Syntax:** `[label] LSRF f{,d}`

**Operands:**  $0 \leq f \leq 127$   
 $d \in [0,1]$

**Operation:**  $0 \rightarrow \text{dest}<7>$   
 $(f<7:1>) \rightarrow \text{dest}<6:0>$ ,  
 $(f<0>) \rightarrow C$ ,

**Status Affected:** C, Z

**Description:** The contents of register 'f' are shifted one bit to the right through the Carry flag. A '0' is shifted into the MSb. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f'.



## MOVF Move f

**Syntax:** `[label] MOVF f,d`

**Operands:**  $0 \leq f \leq 127$   
 $d \in [0,1]$

**Operation:**  $(f) \rightarrow (\text{dest})$

**Status Affected:** Z

**Description:** The contents of register f is moved to a destination dependent upon the status of d. If d = 0, destination is W register. If d = 1, the destination is file register f itself. d = 1 is useful to test a file register since status flag Z is affected.

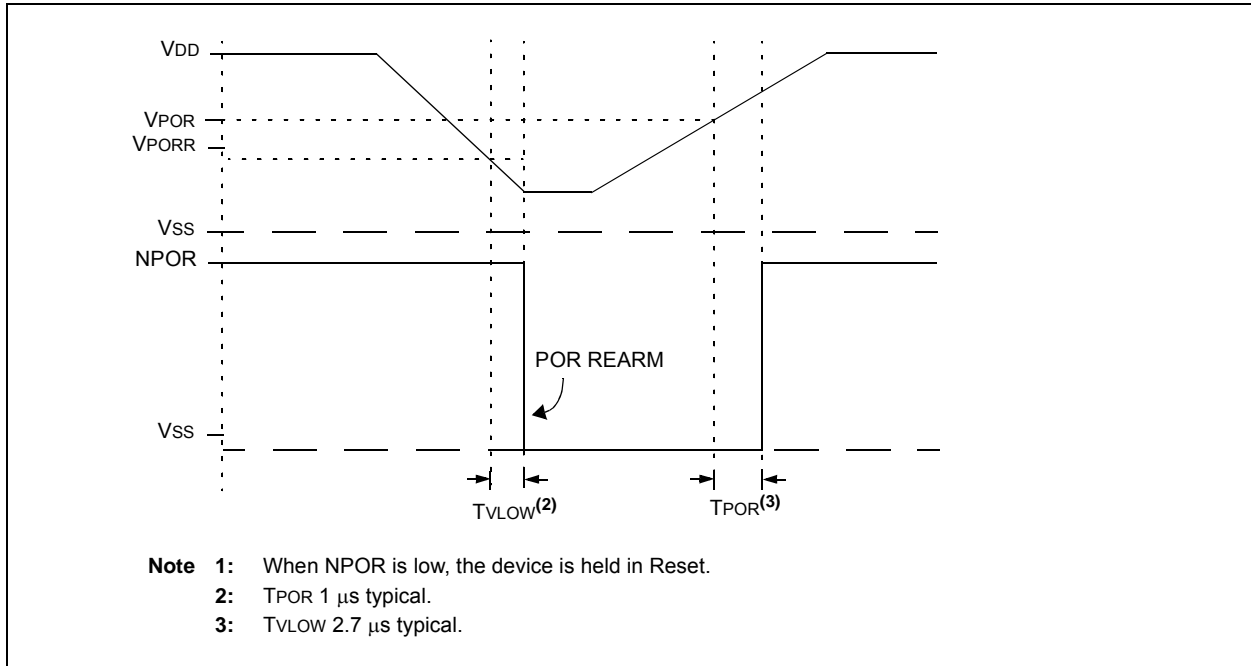
**Words:** 1

**Cycles:** 1

**Example:** `MOVF FSR, 0`

After Instruction  
W = value in FSR register  
Z = 1

**FIGURE 30-4: POR AND POR REARM WITH SLOW RISING  $V_{DD}$**



**TABLE 30-8: PIC16(L)F1934/6/7 A/D CONVERTER (ADC) CHARACTERISTICS:**

Standard Operating Conditions (unless otherwise stated)							
Operating temperature Tested at 25°C							
Param No.	Sym.	Characteristic	Min.	Typ†	Max.	Units	Conditions
AD01	NR	Resolution	—	—	10	bit	
AD02	EIL	Integral Error	—	—	±1.7	LSb	VREF = 3.0V
AD03	EDL	Differential Error	—	—	±1	LSb	No missing codes VREF = 3.0V
AD04	EOFF	Offset Error	—	—	±2.5	LSb	VREF = 3.0V
AD05	EGN	Gain Error	—	—	±2.0	LSb	VREF = 3.0V
AD06	VREF	Reference Voltage <sup>(3)</sup>	1.8	—	VDD	V	VREF = (VREF+ minus VREF-) ( <b>Note 5</b> )
AD07	VAIN	Full-Scale Range	VSS	—	VREF	V	
AD08	ZAIN	Recommended Impedance of Analog Voltage Source	—	—	10	kΩ	Can go higher if external 0.01μF capacitor is present on input pin.

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- Note 1:** Total Absolute Error includes integral, differential, offset and gain errors.
- Note 2:** The A/D conversion result never decreases with an increase in the input voltage and has no missing codes.
- Note 3:** ADC VREF is from external VREF, VDD pin or FVR, whichever is selected as reference input.
- Note 4:** When ADC is off, it will not consume any current other than leakage current. The power-down current specification includes any such leakage from the ADC module.
- Note 5:** FVR voltage selected must be 2.048V or 4.096V.

**TABLE 30-9: PIC16(L)F1934/6/7 A/D CONVERSION REQUIREMENTS**

Standard Operating Conditions (unless otherwise stated)							
Operating temperature -40°C ≤ TA ≤ +125°C							
Param No.	Sym.	Characteristic	Min.	Typ†	Max.	Units	Conditions
AD130*	TAD	A/D Clock Period	1.0	—	9.0	μs	TOSC-based
		A/D Internal RC Oscillator Period	1.0	2.5	6.0	μs	ADCS<1:0> = 11 (ADRC mode)
AD131	TCNV	Conversion Time (not including Acquisition Time) <sup>(1)</sup>	—	11	—	TAD	Set GO/DONE bit to conversion complete
AD132*	TACQ	Acquisition Time	—	5.0	—	μs	

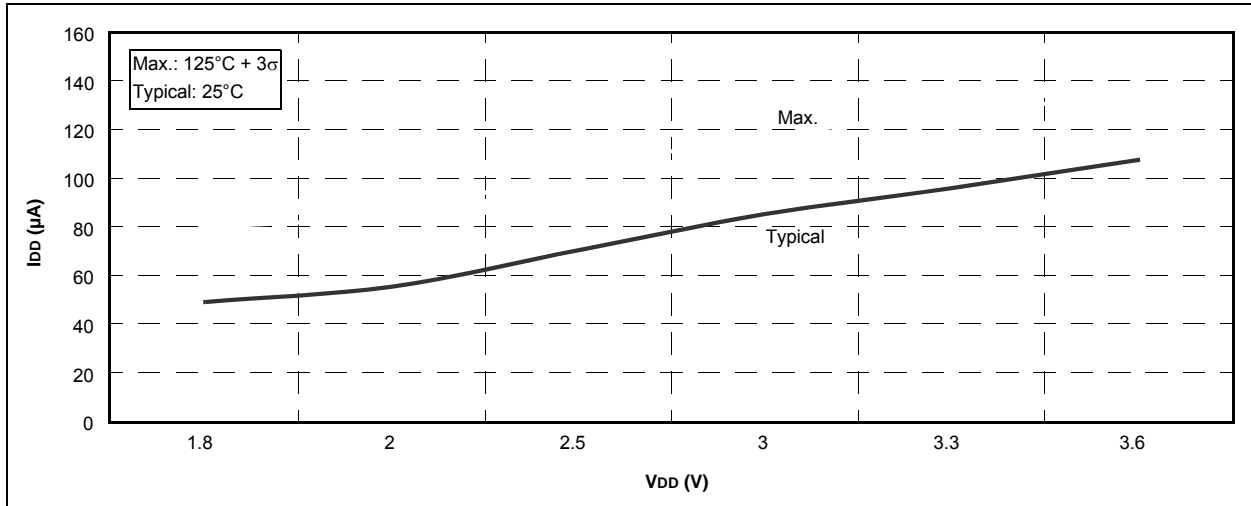
\* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

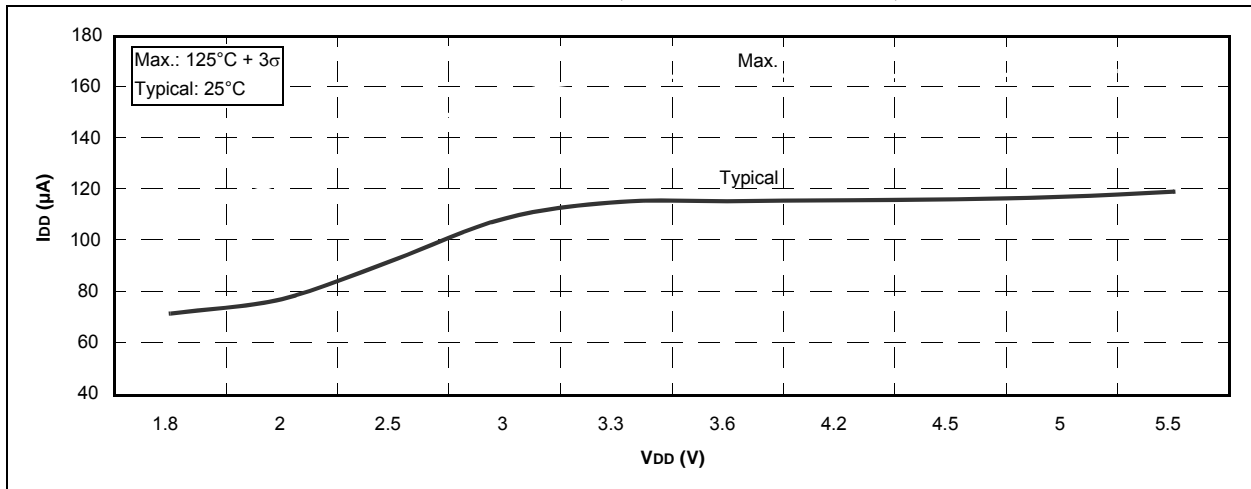
- Note 1:** The ADRES register may be read on the following Tcy cycle.



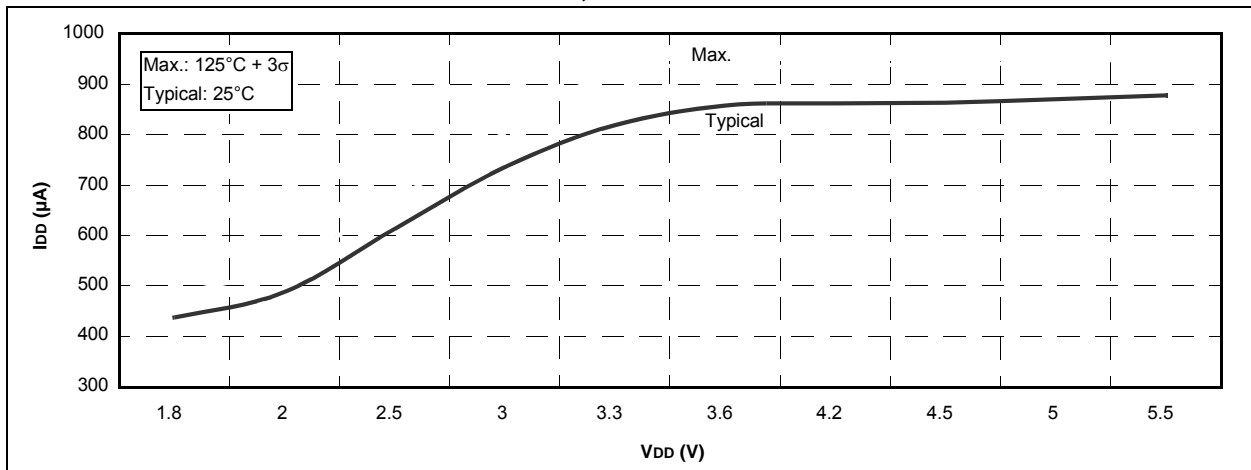
**FIGURE 31-38: PIC16LF1937 EC OSCILLATOR, LOW-POWER MODE,  $F_{osc} = 500$  kHz**



**FIGURE 31-39: PIC16F1937 EC OSCILLATOR, LOW-POWER MODE,  $F_{osc} = 500$  kHz**

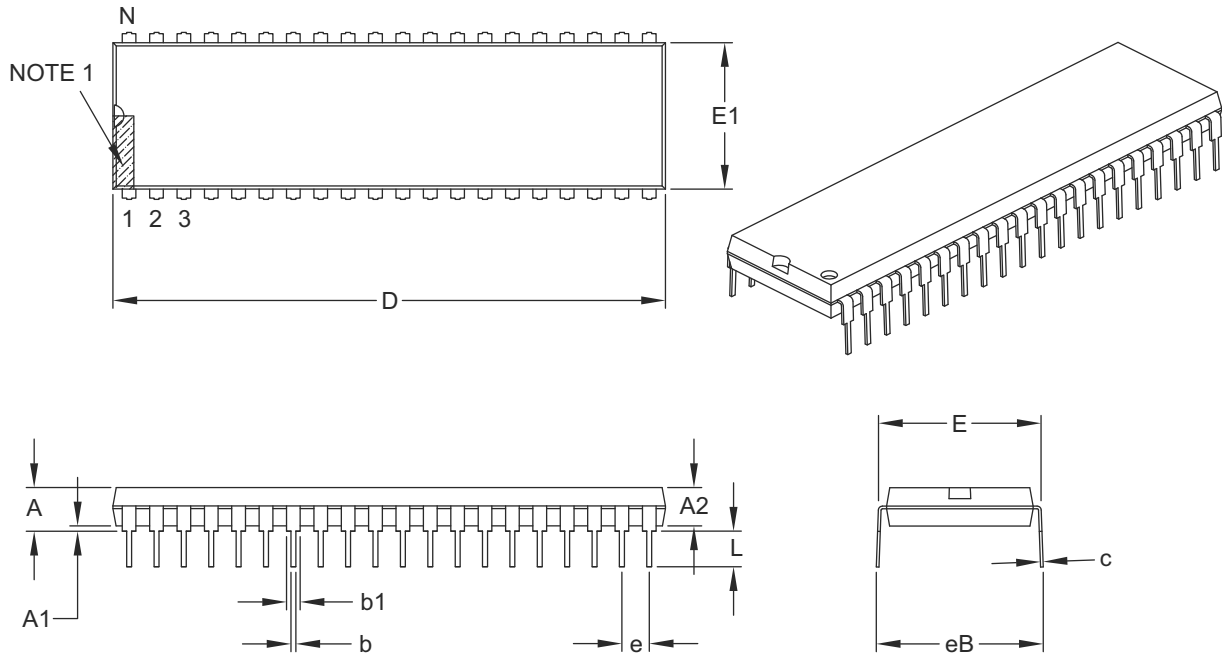


**FIGURE 31-40: PIC16F1937 EXTRC MODE,  $F_{osc} = 4$  MHz**



## 40-Lead Plastic Dual In-Line (P) – 600 mil Body [PDIP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		INCHES		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N	40		
Pitch	e	.100 BSC		
Top to Seating Plane	A	–	–	.250
Molded Package Thickness	A2	.125	–	.195
Base to Seating Plane	A1	.015	–	–
Shoulder to Shoulder Width	E	.590	–	.625
Molded Package Width	E1	.485	–	.580
Overall Length	D	1.980	–	2.095
Tip to Seating Plane	L	.115	–	.200
Lead Thickness	c	.008	–	.015
Upper Lead Width	b1	.030	–	.070
Lower Lead Width	b	.014	–	.023
Overall Row Spacing §	eB	–	–	.700

### Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- Dimensioning and tolerancing per ASME Y14.5M.

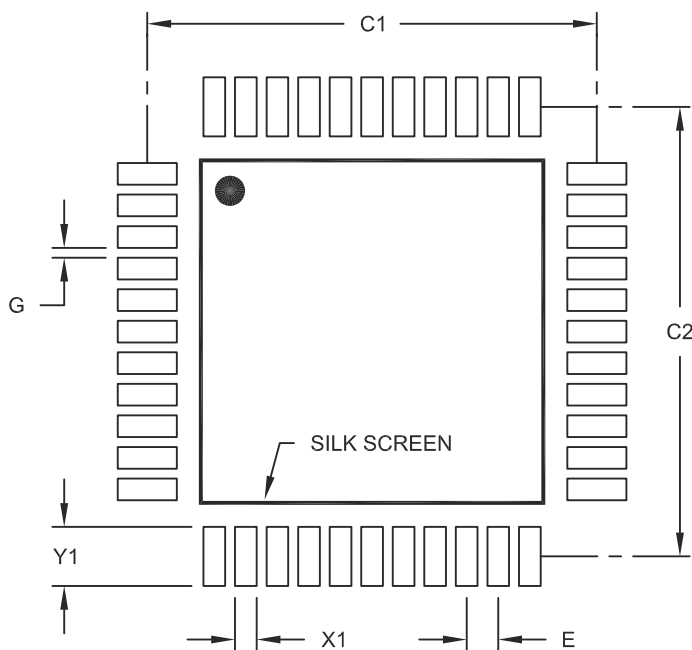
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-016B

# PIC16(L)F1934/6/7

## 44-Lead Plastic Thin Quad Flatpack (PT) – 10x10x1 mm Body, 2.00 mm [TQFP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.80 BSC	
Contact Pad Spacing	C1		11.40	
Contact Pad Spacing	C2		11.40	
Contact Pad Width (X44)	X1			0.55
Contact Pad Length (X44)	Y1			1.50
Distance Between Pads	G	0.25		

**Notes:**

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2076A

Baud Rates, Asynchronous Modes .....	307
Formulas .....	306
High Baud Rate Select (BRGH Bit) .....	305
Synchronous Master Mode .....	314, 318
Associated Registers	
Receive .....	317
Transmit .....	315
Reception .....	316
Transmission .....	314
Synchronous Slave Mode	
Associated Registers	
Receive .....	319
Transmit .....	318
Reception .....	319
Transmission .....	318
Extended Instruction Set	
ADDFSR .....	371
<b>F</b>	
Fail-Safe Clock Monitor .....	81
Fail-Safe Condition Clearing .....	81
Fail-Safe Detection .....	81
Fail-Safe Operation .....	81
Reset or Wake-up from Sleep .....	81
Firmware Instructions .....	367
Fixed Voltage Reference (FVR)	
Associated Registers .....	158
Flash Program Memory .....	117
Erasing .....	122
Modifying .....	126
Writing .....	122
FSR Register 39, 40, 41, 42, 43, 44, 45, 46, 47, 48, 49, 51, 52	
FVRCON (Fixed Voltage Reference Control) Register .....	158
<b>I</b>	
I <sup>2</sup> C Mode (MSSP)	
Acknowledge Sequence Timing .....	280
Bus Collision	
During a Repeated Start Condition .....	284
During a Stop Condition .....	285
Effects of a Reset .....	281
I <sup>2</sup> C Clock Rate w/BRG .....	287
Master Mode	
Operation .....	272
Reception .....	278
Start Condition Timing .....	274, 275
Transmission .....	276
Multi-Master Communication, Bus Collision and Arbitration .....	281
Multi-Master Mode .....	281
Read/Write Bit Information (R/W Bit) .....	257
Slave Mode	
Transmission .....	262
Sleep Operation .....	281
Stop Condition Timing .....	280
INDF Register 39, 40, 41, 42, 43, 44, 45, 46, 47, 48, 49, 51, 52	
Indirect Addressing .....	56
Instruction Format .....	368
Instruction Set .....	367
ADDLW .....	371
ADDWF .....	371
ADDWFC .....	371
ANDLW .....	371
ANDWF .....	371
BRA .....	372
CALL .....	373

CALLW .....	373
LSLF .....	375
LSRF .....	375
MOVF .....	375
MOVIW .....	376
MOVLB .....	376
MOVWI .....	377
OPTION .....	377
RESET .....	377
SUBWFB .....	379
TRIS .....	380
BCF .....	372
BSF .....	372
BTFSC .....	372
BTFSS .....	372
CALL .....	373
CLRF .....	373
CLRWF .....	373
CLRWDI .....	373
COMF .....	373
DECF .....	373
DECFSZ .....	374
GOTO .....	374
INCF .....	374
INCFSZ .....	374
IORLW .....	374
IORWF .....	374
MOVLW .....	376
MOVWF .....	376
NOP .....	377
RETFIE .....	378
RETLW .....	378
RETURN .....	378
RLF .....	378
RRF .....	379
SLEEP .....	379
SUBLW .....	379
SUBWF .....	379
SWAPF .....	380
XORLW .....	380
XORWF .....	380
INTCON Register .....	100
Internal Oscillator Block	
INTOSC	
Specifications .....	397
Internal Sampling Switch (Rss) Impedance .....	169
Internet Address .....	471
Interrupt-On-Change .....	153
Associated Registers .....	155
Interrupts .....	95
ADC .....	164
Associated registers w/ Interrupts .....	107
Configuration Word w/ Clock Sources .....	85
Configuration Word w/ LDO .....	109
TMR1 .....	201
INTOSC Specifications .....	397
IOCBF Register .....	154
IOCBN Register .....	154
IOCBP Register .....	154

## L

LATA Register .....	135, 144
LATB Register .....	140
LATD Register .....	147
LATE Register .....	151
LCD	

SPI Slave Mode (CKE = 1) .....	408
Synchronous Reception (Master Mode, SREN) .....	317
Synchronous Transmission .....	315
Synchronous Transmission (Through TXEN) .....	315
Timer0 and Timer1 External Clock .....	401
Timer1 Incrementing Edge .....	201
Two Speed Start-up .....	80
Type-A in 1/2 MUX, 1/2 Bias Drive .....	347
Type-A in 1/2 MUX, 1/3 Bias Drive .....	349
Type-A in 1/3 MUX, 1/2 Bias Drive .....	351
Type-A in 1/3 MUX, 1/3 Bias Drive .....	353
Type-A in 1/4 MUX, 1/3 Bias Drive .....	355
Type-A/Type-B in Static Drive .....	346
Type-B in 1/2 MUX, 1/2 Bias Drive .....	348
Type-B in 1/2 MUX, 1/3 Bias Drive .....	350
Type-B in 1/3 MUX, 1/2 Bias Drive .....	352
Type-B in 1/3 MUX, 1/3 Bias Drive .....	354
Type-B in 1/4 MUX, 1/3 Bias Drive .....	356
USART Synchronous Receive (Master/Slave) .....	406
USART Synchronous Transmission (Master/Slave) .....	405
Wake-up from Interrupt .....	112
Timing Diagrams and Specifications	
PLL Clock .....	397
Timing Parameter Symbolology .....	395
Timing Requirements	
I <sup>2</sup> C Bus Data .....	411
I2C Bus Start/Stop Bits .....	410
SPI Mode .....	409
TMR0 Register .....	39
TMR1H Register .....	39
TMR1L Register .....	39
TMR2 Register .....	39, 47
TRIS .....	380
TRISA Register .....	40, 135
TRISB .....	138
TRISB Register .....	40, 140
TRISC .....	143
TRISC Register .....	40, 144
TRISD .....	146
TRISD Register .....	40, 147
TRISE .....	149
TRISE Register .....	40, 150
Two-Speed Clock Start-up Mode .....	79
TXCON (Timer2/4/6) Register .....	211
TXREG .....	295
TXREG Register .....	42
TXSTA Register .....	42, 302
BRGH Bit .....	305

## U

### USART

#### Synchronous Master Mode

Requirements, Synchronous Receive .....	406
Requirements, Synchronous Transmission .....	406
Timing Diagram, Synchronous Receive .....	406
Timing Diagram, Synchronous Transmission .....	405

## V

VREF. SEE ADC Reference Voltage

## W

Wake-up on Break .....	311
Wake-up Using Interrupts .....	112
Watchdog Timer (WDT) .....	90
Associated Registers .....	116
Configuration Word w/ Watchdog Timer .....	116
Modes .....	114
Specifications .....	401
WCOL .....	273, 276, 278, 280
WCOL Status Flag .....	273, 276, 278, 280
WDTCON Register .....	115
WPUB Register .....	141
Write Protection .....	65
WWW Address .....	471
WWW, On-Line Support .....	14